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22909	7590 03/02/2006		EXAMINER	
BANNER & WITCOFF, LTD.			MUROMOTO.	IR, ROBERT H
1001 G STREET, N.W. WASHINGTON, DC 20001-4597			ART UNIT	PAPER NUMBER
	,		3765	

DATE MAILED: 03/02/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

		Application No.	Applicant(s)			
Office Action Summary		10/077,548	SURVE, SWATEE N.			
		Examiner	Art Unit			
		Robert H. Muromoto, Jr.	3765			
	The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply					
A SH WHIC - Exter after - If NO - Failu Any I	ORTENED STATUTORY PERIOD FOR REPLY CHEVER IS LONGER, FROM THE MAILING DANSIONS of time may be available under the provisions of 37 CFR 1.13 SIX (6) MONTHS from the mailing date of this communication. Period for reply is specified above, the maximum statutory period were to reply within the set or extended period for reply will, by statute, reply received by the Office later than three months after the mailing and patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tim rill apply and will expire SIX (6) MONTHS from a cause the application to become ABANDONE	l. ely filed the mailing date of this communication. D (35 U.S.C. § 133).			
Status						
2a)□	Responsive to communication(s) filed on <u>03 At</u> This action is FINAL . 2b) This Since this application is in condition for allowar closed in accordance with the practice under E	action is non-final. nce except for formal matters, pro				
Dienoeiti	on of Claims					
5)□ 6)⊠ 7)□	Claim(s) 1-25 is/are pending in the application. 4a) Of the above claim(s) is/are withdraw Claim(s) is/are allowed. Claim(s) 1-25 is/are rejected. Claim(s) is/are objected to. Claim(s) are subject to restriction and/or					
Applicati	on Papers					
10)	The specification is objected to by the Examiner The drawing(s) filed on is/are: a) acce Applicant may not request that any objection to the o Replacement drawing sheet(s) including the correcti The oath or declaration is objected to by the Example.	epted or b) objected to by the Edrawing(s) be held in abeyance. See on is required if the drawing(s) is objected	37 CFR 1.85(a). ected to. See 37 CFR 1.121(d).			
Priority u	nder 35 U.S.C. § 119					
 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of: 1. Certified copies of the priority documents have been received. 2. Certified copies of the priority documents have been received in Application No 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 						
	e of References Cited (PTO-892)	4) 🔲 Interview Summary (PTO-413)			
2) 🔲 Notice 3) 🔲 Inforn	e of Draftsperson's Patent Drawing Review (PTO-948) nation Disclosure Statement(s) (PTO-1449 or PTO/SB/08) No(s)/Mail Date	Paper No(s)/Mail Da				

DETAILED ACTION

Examiner's Comment

Upon review of the appeal brief filed 8/3/2005, the previous rejections have been modified and are presented below. The majority of rejections remain. The rejection with respect to claim 12 and its dependent claim 23 are modified with respect to the fact that claim 12 is actually broader in scope than other independent claims because claim 12 does not require a fiber surface. The fiber limitation is not introduced into this group of claims until claim 22 and claim 22 does not intervene any other claims of this group. Also this group of claims does not introduce the laser spray process so Miller is not needed in the rejection with regard to this group. Claim 3 and 13 are also now in the 102b rejection as Post also clearly states an embodiment using a substrate surface material.

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

Claims 1, 3-22, 24 and 25 are rejected under 35 U.S.C. 102(b) as being anticipated by Post et al. '771.

Post discloses the <u>fabrication of electronic devices and circuits</u>, and in particular to the integration of such devices and circuits into textiles (fabrics, clothing material).

Post discloses a fabric woven with non-conductive fibers in the warp and a conductive

fiber in the weft. The conductive fibers 110 may be continuously adjacent along the weft (substrate). The leads of a resistor and a **capacitor** 122 (claim 11, 21), as well as the pins of an integrated circuit 124 are **soldered to** single fibers of the fabric 100 (col.4, lines 15-51). A fabric comprising a woven matrix of conductive fibers running in both directions can be used to capacitively or <u>electrically couple electronic</u> components, or in sheet form can serve as an electrostatic antenna (claim 10, 20).

To prevent fibers 110 from making unwanted contact as a result of folding, the fabric 100 may be provided with a non-conductive (insulating, protective, shield, claims 4-8, and 14-18) coating (e.g., a transparent acrylic coating that may be sprayed on) following affixation of the electronic components. Alternatively, an insulating layer 135 may be applied to one or both sides of the fabric 100. Insulating layer can, if desired, be a textile with handling characteristics similar to those of the fabric 100 (col. 4, lines 58-65).

Electrically active textiles can also be created by sewing, embroidery or weaving of conductive material into a substantially non-conductive <u>fabric matrix or substrate</u>. (claim 3, 13) Typically, the threads are formed by spinning together fibers of a polymer (plastic, claim 24) such as KEVLAR® with fibers of a metal.

Another embodiment uses an elastic (e.g., foam, claim 25) panel to provide resistance in a switching mechanism for the circuit.

In yet another embodiment, the strips of conductor material may be coated with a semiconductor to form nonlinear thresholding elements at the overlap regions that

prevent false contacts and/or phantom switching. The use of the semiconductor makes the electrical component a transistor, as recited by the applicant in claims 9 and 19.

Claim 23 (dependent to claim 12) is rejected under 35 U.S.C. 102(b) as being anticipated by Carroll.

Carroll discloses, "A microcomputer support and interconnection structure 10 in accordance with the present invention broadly includes a pliable garment 12, a plurality of microcomputer card pockets or enclosures 14, 16, 18, arranged in a predetermined pattern and a linking or signal transmission system 20. The garment 12 and the pockets 14, 16, 18 may be constructed of the same type of cloth or other pliable material or may be composed of different types of body conforming, pliable material such as are commonly used in the manufacture of garments."

"The garment 12 is composed of one or more layers 30 including structure defining a plurality of channels 32. The channels 32 extend between and into each of the pockets 14, 16, 18 in a predetermined sequence. The channels 32 present a characteristic width of sufficient size to encase a flat flexible substrate; such as ribbon cable common in the computer industry. The sequence of the channels 32 is dependent on the functional configuration of the microcomputer system chosen by the user. It will be understood that the channels 32 may be defined by a plurality of layers 30 or may be defined by a plurality of securing loops. The securing loops, for example, are made by securing string or thread to mesh or net fabric."

Carroll states that the support or interconnection layer can be composed of cloth or leather, as leather is a common, low price pliant material for garments.

The computer system and linking systems and channels of Carroll clearly are brought together to form electronic components and are clearly "formed over a surface of the piece of clothing". The term "forming" is extremely broad and has no special meaning assigned to it by the applicant.

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claim 2 and 3 are rejected under 35 U.S.C. 103(a) as being unpatentable over Post et al., in view of Miller 6,251,488.

Although Post teaches essentially all of the limitations of the instant invention there is no teaching of using a laser spray process to form the electrical components on the fibers and the use of a substrate over the fibers.

Miller does teach a laser spray deposition process to affix electronic components to surfaces such as metals, plastics, polymer resins, glass, and the like. The process allows the advantage of very precise direct deposition of electronic components into small areas. Synthetic fibers are polymer resins. And clearly fall within the technical area recited by Miller.

To further clarify the non-critical or obvious nature of using the spray deposition process, as stated in applicant's own specification on page 8, paragraph 28, and on page 9, lines 11-15, "It should be noted that the substrate 203, the protective layer 225, and the shielding layer 227 can each be created using the techniques disclosed in the Miller patent referenced above. Because these structures do not require a high degree of resolution, however, these structures can also be formed using less precise techniques, such as simply dipping the fiber 203 in a liquid form of the material to be used for the substrate 203, the protective layer 225, or the shielding layer 227. <u>These structures can also be formed by, e.g., conventional gas deposition, spraying, or any other suitable technique (page 8, paragraph 28, instant specification)."</u>

"Thus those of ordinary skill in the art will understand that, according to the teachings of the invention, any structure that can be fabricated using the Miller technique or other suitable technique can be formed on a fiber in such a way that the fiber may be subsequently woven into a fabric for clothing or other articles of wear (page 9, lines 11-15, instant specification)."

This citation admits the obviousness of using the techniques of Miller or any other suitable process for depositing electronic components and a substrate onto fibers as recited in claims 2, 3.

In addition there is a clear teaching from Miller that the use of this direct deposition process is suitable for polymer resin surfaces (synthetic fibers are clearly polymer resin surfaces) and the advantage is a very precise method to deposit electronic components onto very small areas.

Application/Control Number: 10/077,548 Page 7

Art Unit: 3765

Therefore it would have been obvious to one of ordinary skill in the art at the time of invention to modify the Post article to use a spray deposition process as taught by Miller rather than soldering, for more precisely depositing electronic materials onto small areas such as fibers to be woven into fabric articles.

Response to Arguments

Applicant's arguments filed 8/3/2005 have been fully considered but they are not persuasive. Applicant argues that Post does not teach "forming an electronic component on either a fiber or over a surface of a piece of clothing material".

It is the examiner's position that Post clearly shows the forming of an electronic component on a fiber or over a surface of cloth material. Especially important disclosures from Post have been italicized above for emphasis, no new recitations have been added to the previous rejection.

This citation taken from the applicant's remarks, "... electronic components are then connected to the conductive fibers by, e.g., soldering..." This statement describes the forming of an electronic component over the surface of a fiber and therefore over a cloth material. The electronic components are soldered to the fabric and thus forms a new electronic component, which is equivalent to "forming on a surface of a piece of clothing material." as recited in the claims.

When using the broadest reasonable interpretation, Post clearly anticipates the limitation, "forming an electronic component on either a fiber or over a surface of a piece of clothing material.

Application/Control Number: 10/077,548 Page 8

Art Unit: 3765

The Examiner cites, Webster's dictionary for a definition of the word "on" recited in the independent claims. "On: used as a function word to indicate presence within the confines of"; Post discloses, "The leads of a resistor 120 and a capacitor 122, as well as the pins of an integrated circuit 124 are soldered to single fibers of the fabric 100 (col. 4, lines 35-40)." The soldering of electronic components clearly meets the definition of "forming electronic components on a fiber" and "over a clothing material" as the surface of the fibers is the surface of the clothing material. It appears applicant is assigning more to the term "forming" than is the broadest reasonable interpretation of the term. If applicant intends to recited specific construction requirements to the invention than the applicant should clearly and positively recite these requirements. The term "form" is extremely broad and presents almost no limiting process steps or structure to the claimed invention.

Applicant's argument with respect to claim 2 are not persuasive. The rejection modifies the Post patent with clear teachings from Miller as cited above. The examiner has cited applicant's specification only to highlight the non-critical nature with which applicant has presented the use of various suitable metal deposition processes. As well as the fact, that applicant admits that "one of ordinary skill in the art could use the Miller process or any other suitable technique" to deposit electronic components onto fibers to be woven into garments.

Applicant's argument with respect to claim 23 is not persuasive, leather and artificial leather have been used as materials for all types of clothing to take advantage of leather's intrinsic properties (low cost, durability, aesthetic). The examiner as

Application/Control Number: 10/077,548 Page 9

Art Unit: 3765

evidence has cited a wearable personal computer that teaches leather as a low cost and flexible material as a possible material. A wearable personal computer is clearly in the same problem solving area as the instant invention. Additionally, the use of leather or synthetic leather in all types of apparel is not novel.

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Robert H Muromoto, Jr. whose telephone number is 571-272-4991. The examiner can normally be reached on 8-530, M-F.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, John Calvert can be reached on 703-305-1025. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Bobby Muromoto Patentlexaminer 2/28/2005